

#### FEATURES

- RF AGC Amplifier, Mixer, and IF Amplifier Circuits
- Low Distortion
- 5-V Power Supply
- 16-Pin TSSOP Package

### APPLICATION

CATV

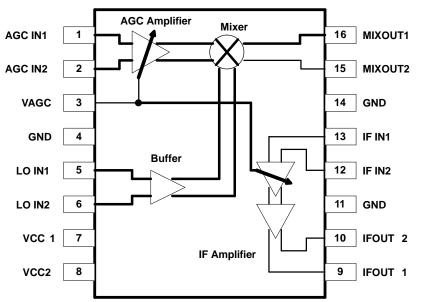
	(TOP VIEW)		
AGC IN1	10	16	MIXOUT1
AGC IN2	2	15	MIXOUT2
VAGC 🗖	3	14	GND
GND 🗖	4	13	IF IN1
LO IN1 🗖	5	12	IF IN 2
LO IN 2 🗖	6	11	GND
VCC1	7	10	IFOUT1
VCC2	8	9	IFOUT2

**16-PIN TSSOP** 

## DESCRIPTION

The SN761688 is a monolithic IC designed as an out-of-band tuner for CATV. The circuit consists of an RF AGC amplifier, mixer, and IF amplifier, and is available in a small-outline package.

## FUNCTIONAL BLOCK DIAGRAM



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

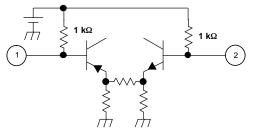
# SN761688 **DOWN CONVERTER**

SLES178-APRIL 2006

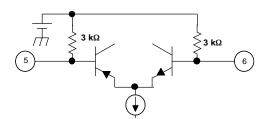


#### **TERMINAL FUNCTIONS**

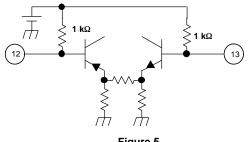
TERMINAL		DESCRIPTION	SCHEMATIC		
NAME	NO.	DESCRIPTION	SCHEMATIC		
AGC IN1	1	Input of AGC amplifier	Figure 1		
AGC IN2	2				
VAGC	3	Input of gain control voltage	Figure 2		
GND	4, 11, 14	Ground			
LO IN1	5	Input of local OSC	Figure 3		
LO IN2	6				
VCC1	7	5 V power supply; AGC/Mixer/Buffer			
VCC2	8	5 V power supply; IF amplifier			
IF OUT1	9	Output of IF amplifier	Figure 4		
IF OUT2	10				
IF IN2	12	Input of IF amplifier	Figure 5		
IF IN1	13				
MIXOUT2	15	Output of Mixer	Figure 6		
MIXOUT1	16				













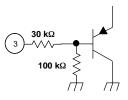


Figure 2.

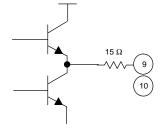
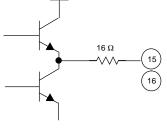


Figure 4.



## ABSOLUTE MAXIMUM RATINGS

over operating free-air temperature range (unless otherwise noted) <sup>(1)</sup>

Supply voltage, V <sub>CC</sub> <sup>(2)</sup>	VCC1,2 (Pin 7, 8)	–0.4 V to 6.5 V
Input voltage <sup>(2)</sup>	V <sub>IN</sub> (Pins 1, 2, 3, 5, 6, 12, 13)	-0.4 V to VCC
Continuous total dissipation, P <sub>D</sub> <sup>(3)</sup>	$T_A \le 25^{\circ}C$	775 mW
Maximum junction temperature, T <sub>J</sub>		150°C

 Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) Voltage values are with respect to the GND of the circuit.

(3) Derating factor is 6.2 mW/°C for  $T_A \ge 25^{\circ}C$ .

## **RECOMMENDED OPERATING CONDITIONS**

over operating free-air temperature range (unless otherwise noted)

	MIN	NOM	MAX	UNIT
Supply voltage, V <sub>CC</sub>	4.5	5	5.5	V
Operating free-air temperature, T <sub>A</sub>	-20		85	°C

### DC ELECTRICAL CHARACTERISTICS

 $V_{CC} = 5 \text{ V}, \text{ } \text{T}_{A} = 25^{\circ}\text{C}, \text{ unless otherwise noted}$ 

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
I <sub>CC</sub>	Supply current	No signal, V <sub>AGC</sub> = 0 V		67		mA
I <sub>IAGC</sub>	Input current (VAGC)	V <sub>AGC</sub> = 3 V		22	33	μA
V <sub>AGCMAX</sub>	AGC voltage high at maximum gain		3		V <sub>CC</sub>	V
V <sub>AGCMIN</sub>	AGC voltage low at minimum gain		0		0.5	V

## **AC ELECTRICAL CHARACTERISTICS**

 $V_{CC} = 5 \text{ V}, \text{ } \text{T}_{A} = 25^{\circ}\text{C}, \text{ unless otherwise noted}$ 

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
	AGC amplifier and mixer <sup>(1)</sup>					
GC <sub>MAX</sub>	Maximum conversion gain	V <sub>AGC</sub> = 3 V	27	30	33	dB
GC <sub>MIN</sub>	Minimum conversion gain	V <sub>AGC</sub> = 0 V	-21	-18	-15	dB
GCR <sub>MIX</sub>	Gain control range	V <sub>AGC</sub> = 0 V to 3 V		48		dB
V <sub>MIXOUT</sub>	Mixer output voltage	V <sub>AGC</sub> = 3 V, Single-ended output		117		dBμV
NF	Noise figure <sup>(2)</sup>	V <sub>AGC</sub> = 3 V		10		dB
IM3 <sub>GMX</sub>	Third order intermodulation distortion	$      f_{\text{IN1}} = 79.5 \text{ MHz}, \      f_{\text{IN2}} = 80.5 \text{ MHz}, \\       V_{\text{OUT}} = -10 \text{ dBm}, \   V_{\text{AGC}} = 3 \text{ V}      $		-60		dBc
OIP3 <sub>GMX</sub>	Output intercept point	$f_{\rm IN1}$ = 79.5 MHz, $f_{\rm IN2}$ = 80.5 MHz, $V_{\rm AGC}$ = 3 V	20		dBm	
	IF amplifier <sup>(3)</sup>	· · · ·				
GV <sub>IFMAX</sub>	Maximum voltage gain	V <sub>AGC</sub> = 3 V		51		dB
GV <sub>IFMIN</sub>	Minimum voltage gain	V <sub>AGC</sub> = 0 V		46		dB
GVR <sub>IF</sub>	Gain control range	V <sub>AGC</sub> = 0 V to 3 V		5		dB
IM3 <sub>IF</sub>	Third order intermodulation distortion	$      f_{\text{IN1}} = 43.5 \text{ MHz}, \\       f_{\text{IN2}} = 445 \text{ MHz}, \\       V_{\text{IFOUT}} = 1 \text{ dBm}, \\       V_{\text{AGC}} = 3 \text{ V} $		-60		dBc
V <sub>IFOUT</sub>	IF amplifier output voltage	V <sub>AGC</sub> = 3 V, Single-ended output		122		dBµV

(1) Measurement Circuit 1 except for Noise Figure measurement. AGC IN = 80 MHz/-37 dBm, LO IN = 36 MHz / -20 dBm, IF = 44 MHz, unless otherwise noted.

(2) Measurement Circuit 2.

(3) Measurement Circuit 3. IF IN = 44 MHz / -50 dBm, unless otherwise noted.



### **APPLICATION INFORMATION**

## MEASUREMENT CIRCUITS

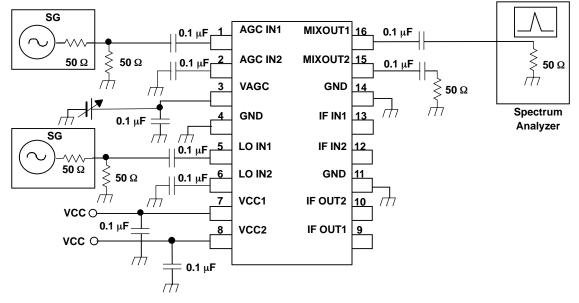
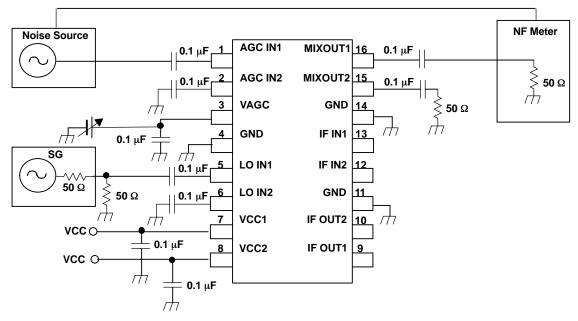


Figure 7. Measurement Circuit 1





#### **APPLICATION INFORMATION (continued)**

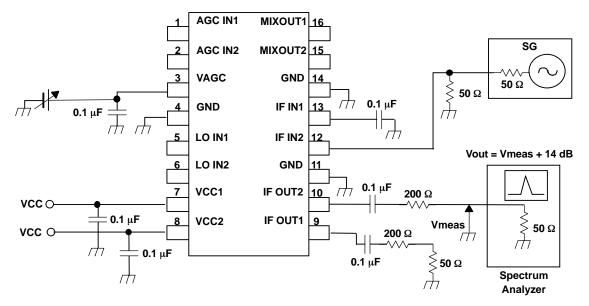


Figure 9. Measurement Circuit 3

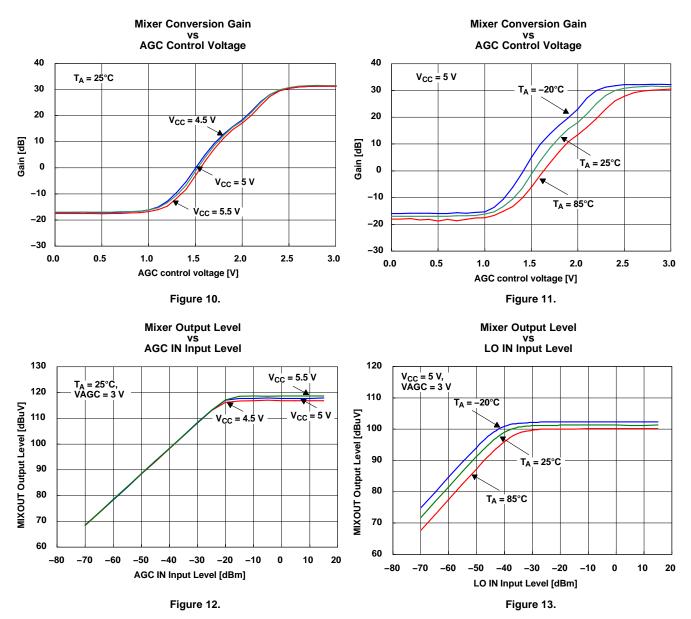
#### NOTE:

This application information is advisory and a performance check is required at the actual application circuits.

Texas Instruments assumes no responsibility for the consequences of use of these application circuits, such as infringement of intellectual property rights or other rights, including patents, of third parties.



## **TYPICAL CHARACTERISTICS**



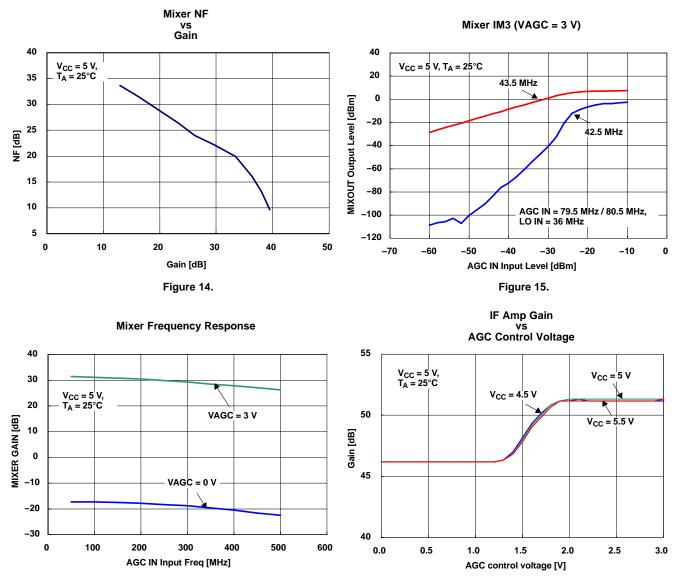
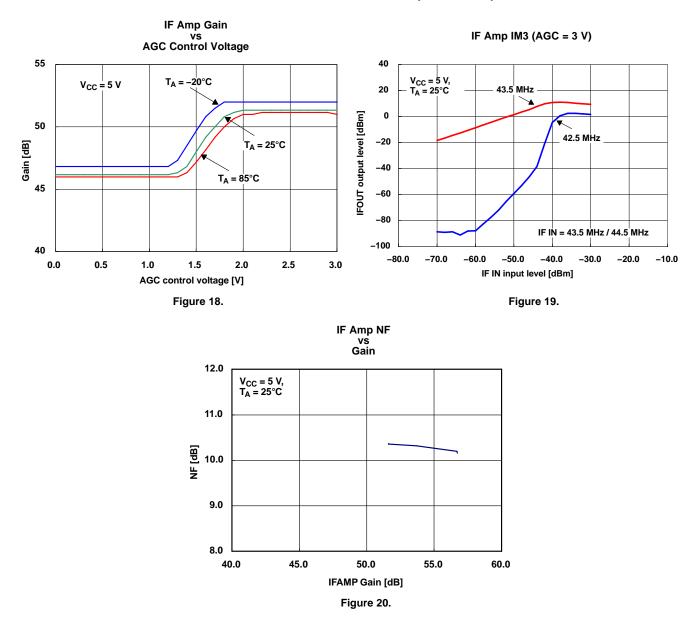


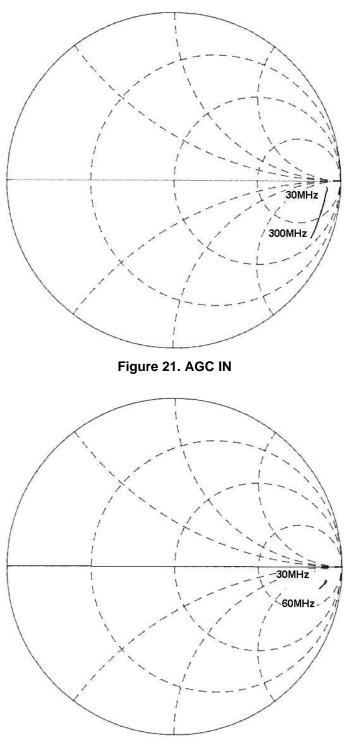
Figure 16.

Figure 17.





## **S-PARAMETER**



## Figure 22. IF IN



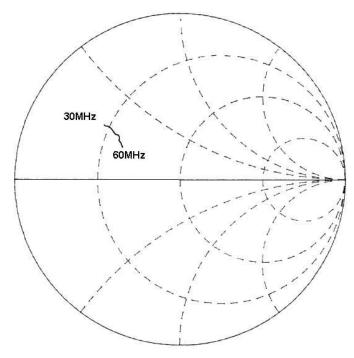


Figure 23. IF OUT

## PACKAGING INFORMATION

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	e Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
SN761688PW	ACTIVE	TSSOP	PW	16	90	TBD	Call TI	Call TI
SN761688PWR	ACTIVE	TSSOP	PW	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN761688PWRG4	ACTIVE	TSSOP	PW	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

**Important Information and Disclaimer:**The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

## **MECHANICAL DATA**

MTSS001C - JANUARY 1995 - REVISED FEBRUARY 1999

## PW (R-PDSO-G\*\*)

#### PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
- D. Falls within JEDEC MO-153



#### **IMPORTANT NOTICE**

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

Products		Applications	
Amplifiers	amplifier.ti.com	Audio	www.ti.com/audio
Data Converters	dataconverter.ti.com	Automotive	www.ti.com/automotive
DSP	dsp.ti.com	Broadband	www.ti.com/broadband
Interface	interface.ti.com	Digital Control	www.ti.com/digitalcontrol
Logic	logic.ti.com	Military	www.ti.com/military
Power Mgmt	power.ti.com	Optical Networking	www.ti.com/opticalnetwork
Microcontrollers	microcontroller.ti.com	Security	www.ti.com/security
		Telephony	www.ti.com/telephony
		Video & Imaging	www.ti.com/video
		Wireless	www.ti.com/wireless

Mailing Address: Texas Instruments

Post Office Box 655303 Dallas, Texas 75265

Copyright © 2006, Texas Instruments Incorporated